

# **High Voltage Switching Diode**

# NSD350H

The NSD350H is a high voltage switching diode in a SOD-323 surface mount package.

#### **Features**

- Small Footprint Package, SOD-323
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- Pb-free Device, Halogen Free/BFR Free and are RoHS Compliant

## **Typical Applications**

- Flat Panel TVs
- · Power Supply
- Industrial
- · Wireless Handsets
- Automotive Modules

# MAXIMUM RATINGS Single Diode (T<sub>A</sub> = 25°C)

Rating	Symbol	Max	Unit
Reverse Voltage	$V_{R}$	350	٧
Forward Current (DC)	IF	200	mA
Non-Repetitive Peak Forward Current (Square Wave, $T_J = 25^{\circ}\text{C}$ prior to surge) $t = 10 \ \mu\text{s}$ $t = 100 \ \mu\text{s}$ $t = 1 \ \text{ms}$ $t = 10 \ \text{ms}$	I <sub>FSM</sub>	12 5 2 1.5	A

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation  T <sub>A</sub> = 25°C  Derate above 25°C	P <sub>D</sub> (Note 1)	250 2	mW mW/°C
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub> (Note 1)	500	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 100 mm<sup>2</sup> 2 oz Cu PCB



### MARKING DIAGRAM



SOD-323 CASE 477 STYLE 1



AJ = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NSD350HT1G	SOD-323	3000 / Tape &
NSVD350HT1G	(Pb-Free)	Reel

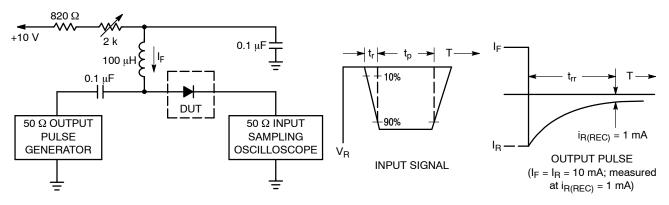
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# NSD350H

Table 1. ELECTRICAL CHARACTERISTICS ( $T_A = 25$ °C)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I <sub>R</sub> = 10 μA)	V <sub>(BR)R</sub>	350			V
Reverse Leakage (V <sub>R</sub> = 300 V)	I <sub>R</sub>			150	nA
Reverse Leakage (V <sub>R</sub> = 350 V)	I <sub>R</sub>			5	μΑ
Forward Voltage (I <sub>F</sub> = 100 mA)	V <sub>F</sub>			1.1	V
Total Capacitance (V <sub>R</sub> = 0 V, f = 1.0 MHz)	C <sub>T</sub>			5.0	pF
Reverse Recovery Time ( $I_F = I_R = 10 \text{ mA}$ , $I_R(\text{rec}) = 1.0 \text{ mA}$ , Figure 1)	t <sub>rr</sub>		55		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



Notes: 1. A 2.0 k $\Omega$  variable resistor adjusted for a Forward Current (IF) of 10 mA.

- 2. Input pulse is adjusted so I<sub>R(peak)</sub> is equal to 10 mA.
- $3. t_p * t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit

# NSD350H

# **TYPICAL CHARACTERISTICS**

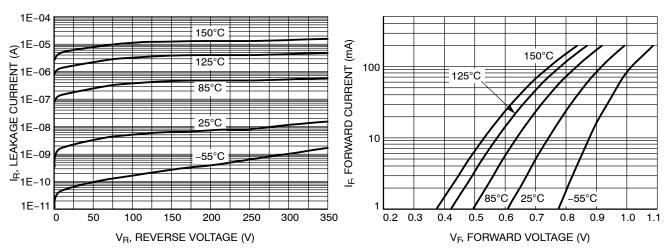


Figure 2. Reverse Leakage Current

Figure 3. Forward Voltage

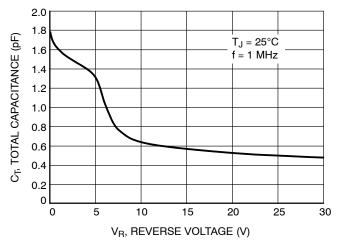


Figure 4. Total Capacitance

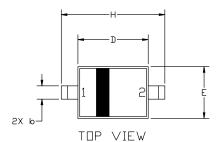






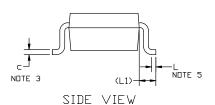
#### SOD-323 1.70x1.25x0.85 **CASE 477 ISSUE K**

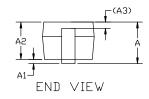
**DATE 11 MAR 2024** 



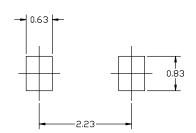
#### NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M, 2018.
- CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH 3. SOLDER PLATING.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
  DIMENSION L IS MEASURE FROM END OF RADIUS.





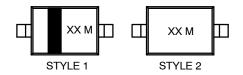
DIM	MILLIMETERS			
ויונע	MIN.	N□M.	MAX.	
Α	0.80	0.90	1.00	
A1	0.00	0.05	0.10	
A2	0.75	0.85	0.95	
А3	0.15 (REF)			
b	0.25	0.32	0.4	
C	0.09	0.12	0.18	
D	1.60	1.70	1.80	
Ε	1.15	1.25	1.35	
Н	2.30	2.50	2.70	
L	0.08			
L1	0.40 (REF)			



#### RECOMMENDED MOUNTING FOOTPRINT

\*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques
Reference manual, SDLDERRM/D.

#### **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLE 2: NO POLARITY PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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DESCRIPTION:	SOD-323 1.70x1.25x0.85		PAGE 1 OF 1	

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